## **UTILITY PATENT APPLICATION TRANSMITTAL** (Large Entity)

(Only for new nonprovisional applications under 37 CFR 1.53(b))

Docket No. 233

Total Pages in this Submission

#### TO THE ASSISTANT COMMISSIONER FOR PATENTS

**Box Patent Application** 

							Washin	gton, D.C. 20231			
		Transmitted herewith for filing under 35 U.S.C. 111(a) and 37 C.F.R. 1.53(b) is a new utility patent application for an									
		invention entitled: SCREENING HOUSING FOR MICROWAVE CIRCUITS									
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		h.	X	Detailed	d Description				on the date indicated above and is addressed to the: Assistant Commissioner for Patents, Washington, D.C. 20231.		
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# UTILITY PATENT APPLICATION TRANSMITTAL (Large Entity)

(Only for new nonprovisional applications under 37 CFR 1.53(b))

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Total Pages in this Submission

		Application Elements (Continued)
3.	X	Drawing(s) (when necessary as prescribed by 35 USC 113)
	a.	Formal Number of Sheets 1
	b.	☐ Informal Number of Sheets
4.	X	Oath or Declaration
	a.	Newly executed (original or copy)
	b.	Copy from a prior application (37 CFR 1.63(d)) (for continuation/divisional application only)
	C.	With Power of Attorney  Without Power of Attorney
	d.	DELETION OF INVENTOR(S) Signed statement attached deleting inventor(s) named in the prior application, see 37 C.F.R. 1.63(d)(2) and 1.33(b).
5.		Incorporation By Reference (usable if Box 4b is checked) The entire disclosure of the prior application, from which a copy of the oath or declaration is supplied under Box 4b, is considered as being part of the disclosure of the accompanying application and is hereby incorporated by reference therein.
6.	$\Box$	Computer Program in Microfiche (Appendix)
7.		Nucleotide and/or Amino Acid Sequence Submission (if applicable, all must be included)
	a.	☐ Paper Copy
	b.	☐ Computer Readable Copy (identical to computer copy)
	C.	Statement Verifying Identical Paper and Computer Readable Copy
		Accompanying Application Parts
8.	X	Assignment Papers (cover sheet & document(s))
9.		37 CFR 3.73(B) Statement (when there is an assignee)
10.		English Translation Document (if applicable)
11.	X	Information Disclosure Statement/PTO-1449   Copies of IDS Citations
12		Deslineinan, Amandraant
12.		Preliminary Amendment
13.	X	Acknowledgment postcard
14.	X	Certificate of Mailing
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# **UTILITY PATENT APPLICATION TRANSMITTAL** (Large Entity)

(Only for new nonprovisional applications under 37 CFR 1.53(b))

Docket No. 233

Total Pages in this Submission

			Ac	companying Ap	plication Pa	ırts (Co	ntinued)	
15.	X	Certified C	opy of Priority	Document(s) (if i	foreign priorit	y is clair	med)	
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BE IT KNOWN that We, Wolfgang KUSCHKE, Hardial Singh GILL, and Willibald Konrath, citizens of Germany, whose post office addresses are, respectively, Im Rank 1, 71570 Oppenweiler, Germany; Elly-Heuss-Knapp-Weg 38/3, 71522 Backnang, Britisch, Eichendorffweg 17, 71554 Weissach, Germany

#### SCREENING HOUSING FOR MICROWAVE CIRCUITS

of which the following is a complete specification:

#### BACKGROUND OF THE INVENTION

The present invention relates to a screening housing for microwave circuits. More particularly, it relates to such a screening housing with a plurality of chambers which are screened from one another and which accommodate circuit units to be oppositely electromagnetically coupled.

Conventionally, a multi-chamber housing which must accommodate a plurality of microwave circuits screened from one another in a high frequency type manner is produced by milling of the individual chambers from a massive metal body. One of such screening housings is disclosed for example in the German document DE 35 04 726 C1. The manufacture of such a housing with several high frequency-tight chambers is very expensive.

Another German patent document DE 43 19 965 A1 discloses a housing with separating joints provided for example between the cover and the housing walls, and sealing profiles inserted in the separating joints and composed of an elastic polymer with embedded metal particles.

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#### SUMMARY OF THE INVENTION

Accordingly, it is an object of the present invention to provide a screening housing of the above mentioned type which avoids the disadvantages of the prior art.

More particularly, it is an object of the present invention to provide a screening housing of the above mentioned general type which can be produced with lower expenses.

In keeping with these objects and with others which will become apparent hereinafter, one feature of present invention resides, briefly stated in a screening housing for microwave circuits, in which on the inner side of the cover which closes the housing, a substrate is arranged of a polymer with embedded metal particles, and webs are provided on the substrate which together with the placed cover form the separating walls between the chambers.

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The substrate with the webs which form the chambers can be cast on the inner side of the cover. Any structure of the substrate with webs can be made without high expenses. The substrate from a polymer with the

embedded metal particles not only performs a screening function, but also dampens simultaneously undesirable resonance frequency in the chambers.

The material of the housing, in particular polymer with the embedded metal particles can be a silicone mass filled with iron powder.

The novel features which are considered as characteristic for the present invention are set forth in particular in the appended claims. The invention itself, however, both as to its construction and its method of operation, together with additional objects and advantages thereof, will be best understood from the following description of specific embodiments when read in connection with the accompanying drawings.

## BRIEF DESCRIPTION OF THE DRAWINGS

Figure 1 is a view showing an open screening housing with its interior, in accordance with the present invention; and

Figure 2 is a view showing the same screening housing from an inner side of its cover.

#### **DESCRIPTION OF PREFERRED EMBODIMENTS**

A screening housing for microwave circuits in accordance with the present invention is identified as a whole with reference numeral 1. The screening housing has a single large chamber 2 which can be produced for example by milling from a metal block. The chamber 2 serves for receiving of microwave circuits which must be screened electromagnetically from outside. The housing 1 is closed with a cover 3.

The separating joints between the housing walls and the cover must be sealed so that no electromagnetic energy can escape outwardly. Several subunits which must be screened magnetically from one another are usually located in such a screening housing. For this purpose, several chambers for receiving individual circuit unit which must be screened electromagnetically from one another are provided in the interior of the housing 1.

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Figure 2 shows how the chambers are formed in the screening housing 1, and a perspective view of the inner side of the housing cover 3 is illustrated. A substrate 4 composed of a polymer with embedded metal particles is arranged on the inner side of the cover 3. The substrate 4 for example is composed of a silicone mass which is filled with iron powder.

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Several webs 5, 6, 7, 8 are provided on the face of the substrate 4 which faces toward the interior of the housing 1. When the cover 3 is placed on the housing, the separating walls 5, 6, 7, 8 together with the cover 3 form the individual chambers inside the screening housing. As shown in the embodiment of Figure 2, the webs 5, 6, 7, 8 can have an arbitrarily complicated structure.

The substrate 4 with the webs 5, 6, 7, 8 can be manufactured in a simple manner by casting with a mold on the inner side of the cover 3. The webs 5, 6, 7, 8 abut in a form-locking manner against the bottom of the chamber 2 when the cover 3 is placed on the housing. Additionally, they can be provided with throughgoing openings 9, 10, 11 for connecting conductors between the individual circuit units.

The webs 5, 6, 7, 8 which are composed of polymer with embedded metal particles have not only the function of screening walls but also dampen simultaneously the undesired resonance frequencies in the chamber.

It will be understood that each of the elements described above, or two or more together, may also find a useful application in other types of constructions differing from the types described above.

While the invention has been illustrated and described as embodied in screening housing for microwave circuits, it is not intended to be limited to the details shown, since various modifications and structural changes may be made without departing in any way from the spirit of the present invention.

Without further analysis, the foregoing will so fully reveal the gist of the present invention that others can, by applying current knowledge, readily adapt it for various applications without omitting features that, from the standpoint of prior art, fairly constitute essential characteristics of the generic or specific aspects of this invention.

What is claimed as new and desired to be protected by Letters

Patent is set forth in the appended claims.

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#### CLAIMS

1. A screening housing for microwave circuits, comprising a housing body having an interior and open at least at one side: a cover closing said interior of said housing; and means forming a plurality of chambers provided for accommodating of individual circuit units and screened from one another, said means including a substrate and applied on an inner side of said cover and a plurality of webs which are formed on said substrate so that when said cover closes said housing said webs form separating walls between said chambers.

2. A screening housing as defined in claim 1, wherein said housing body is composed of an electromagnetic energy screening material.

3. A screening housing as defined in claim 1, wherein said substrate is composed of a polymer with embedded metal particles.

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4. A screening housing as defined in claim 3, wherein said substrate is composed of a silicone mass with embedded metal powder.

5. A screening housing as defined in claim 1, wherein said substrate and said webs are formed of one piece with one another.

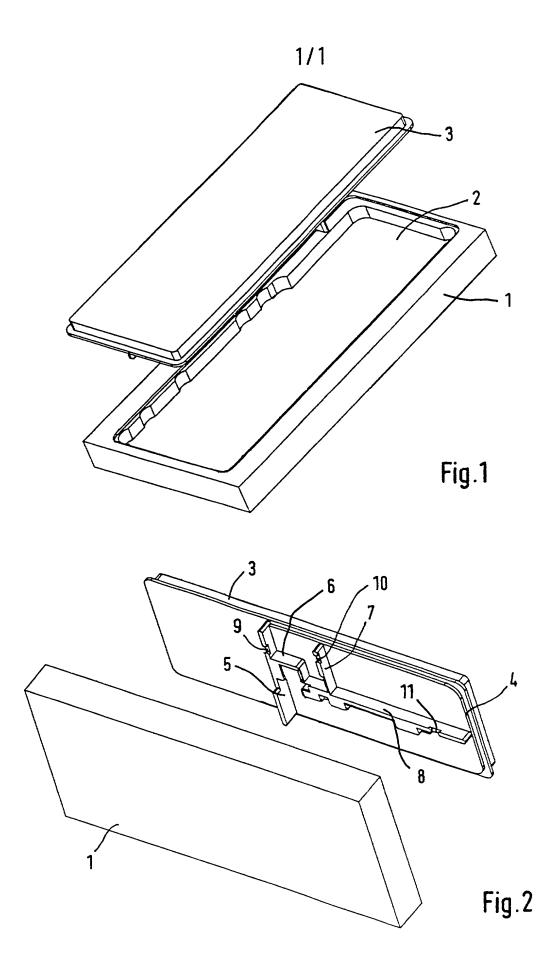
6. A screening housing as defined in claim 5, wherein said substrate and said webs are composed of the same material.

7. A screening housing for microwave circuits, comprising a housing body having an interior and open at least at one side; a cover closing said interior of said housing; and means forming a plurality of chambers provided for accommodating of individual circuit units and screened from one another, said means including a composed of a polymer with embedded metal particles and applied on an inner side of said cover

and a plurality of webs which are formed on said substrates so that when said cover closes said housing said webs form separating walls between said chambers.

### ABSTRACT OF THE DISCLOSURE

A screening housing for microwave circuits has a housing body having an interior and open at least at one side, a cover closing the interior of the housing, and means forming a plurality of chambers provided for accommodating of individual circuit units and screened from one another, the means including a substrate and applied on an inner side of the cover and a plurality of webs which are formed on the substrates so that when the cover closes the housing the webs form separating walls between the chambers.



# COMBINED DECLARATION AND POWER OF ATTORNEY

ATTORNEY DOCKET NO. 233

As a below-named inventor, I hereby declare that:

Wolfgang KUSCHKE Hardial SINGH GILL Willibald KONRATH

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention SCREENING HOUSING FOR MICROWAVE CIRCUITS the specification of which:

(Check one) X is attached hereto.

\_\_\_was filed on\_\_\_\_\_\_as

Application Serial No. \_\_\_\_\_and

was amended on \_\_\_\_\_(if applicable)

was amended through \_\_\_\_\_(if applicable)

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose all information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, Section 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, Section § 119, of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s):

**Priority Claimed** 

1 97 28 839.1-34 Priority Number	DE Country	_ <u>JULY 5, 1997</u> Date filed (Priority Date)	X _Yes	No
Priority Number	Country	Date filed (Priority Date)	Yes	No
Priority Number	Country	Date filed (Priority Date)	Yes	No

I hereby claim the benefit under Title 35, United States Code, Section 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title

35, United States Code, Section 112, I acknowledge the duty to disclose material information as defined
in Title 35, Code of Federal Regulations, Section 1.56(a), which occurred between the filing date of the
prior application and the national or PCT International filing date of this application:

(Application Serial No.)	(Filing Date)	(Status - Patented, pending, abandoned)
(Application Serial No.)	(Filing Date)	(Status - Patented, pending, abandoned)
(Application Serial No.)	(Filing Date)	(Status - Patented, pending, abandoned)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that those statements were made with the knowledge that wilful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such wilful false statements may jeopardize the validity of the application or any patent issued thereon.

The undersigned hereby authorizes **Michael J. Striker** and the firm of **Striker, Striker & Stenby**, to accept and follow instructions from:

#### **ROBERT BOSCH GMBH**

as to any action to be taken in the Patent and Trademark Office regarding this application without direct communication between Michael J. Striker, the firm of Striker, Striker & Stenby, and the undersigned. In the event of a change in the persons from whom instructions may be taken, Michael J. Striker and the firm of Striker, Striker & Stenby will be so notified by the undersigned.

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

POWER OF ATTORNEY: Michael J. Striker, Registration No. 27233

Address all telephone calls to: Michael J. Striker

Telephone number: (212) 687 - 5068

Address all correspondence to: Striker, Striker & Stenby

360 Lexington Avenue New York, New York 10017

U.S.A.

Signature:  X''' 'fy > 'Janua' a  Full Name of First or Sole Inventor:	Date: - メラン、タ8 Citizenship: DE	Residence and Full Postal Address: Im Rank 1 71570 Oppenweiler Germany	
Wolfgang KUSCHKE  Signature:  * Nadal Jal Jul	Date: × 7.5.98	Residence and Full Postal Address: Elly-Heuss-Knapp-Weg 38/3	
Full Name of Second Inventor: Hardial SINGH GILL	Citizenship: GB	71522 Backnang Germany	
Signature:	Date: 7.5.38	Residence and Full Postal Address: Eichendorffweg 17	
Full Name of Third Inventor: Willibald KONRATH	Citizenship: DE	71522 Weissach Germany	
Signature:	Date:	Residence and Full Postal Address:	
Full Name of Fourth Inventor:	Citizenship:		
Signature:	Date:	Residence and Full Postal Address:	
Full Name of Fifth Inventor:	Citizenship:		
Signature:	Date:	Residence and Full Postal Address:	
Full Name of Sixth Inventor:	Citizenship:		
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